

OptiMOS[®]-P Power-Transistor

Feature

- P-Channel
- Enhancement mode
- Logic Level
- Automotive AEC Q101 qualified
- Green package (lead free)
- MSL1 up to 260°C peak reflow temperature
- 175°C operating temperature
- Avalanche rated
- dv/dt rated

• dV/dt rated				Gate
Туре	Package	Ordering Code	Marking	pin1
IPP80P03P3L-04	P- TO220 -3-1	-	3P03L04	*
IPB80P03P3L-04	P- TO263 -3-2	-	3P03L04	*
IPI80P03P3L-04	P- TO262 -3-1	-	3P03L04	•

P- TO262 -3-1

Maximum Ratings, at $T_i = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit	
Continuous drain current ¹⁾	I _D		А	
<i>T</i> _C =25°C		-80		
<i>T</i> _C =100°C		-80		
Pulsed drain current	I _{D puls}	-320		
T _C =25°C				
Avalanche energy, single pulse	E _{AS}	432	mJ	
$I_{\rm D}$ =-80 A , $V_{\rm DD}$ =-25V, $R_{\rm GS}$ =25 Ω				
Reverse diode d <i>v</i> /d <i>t</i>	d <i>v</i> /d <i>t</i>	-6	kV/µs	
/ _S =-80A, V _{DS} =-24V, d <i>i</i> /d <i>t</i> =200A/μs, 7 _{jmax} =175°C				
Gate source voltage	V _{GS}	±20	V	
Power dissipation	P _{tot}	200	W	
<i>T</i> _C =25°C				
Operating and storage temperature	T _j , T _{stg}	-55 +175	°C	
IEC climatic category; DIN IEC 68-1		55/175/56		

Product Summary

V _{DS}	-30	V
R _{DS(on)} max. SMD version	4	mΩ
I _D	-80	Α

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P- TO263 -3-2

P- TO220 -3-1





Thermal Characteristics

Parameter	Symbol		Unit		
		min.	typ.	max.	
Characteristics					
Thermal resistance, junction - case	R _{thJC}	-	0.5	0.75	K/W
Thermal resistance, junction - ambient, leaded	R _{thJA}	-	-	62	
SMD version, device on PCB:	R _{thJA}				
@ min. footprint		-	-	62	
@ 6 cm ² cooling area $^{2)}$		-	-	40	

Electrical Characteristics, at $T_i = 25$ °C, unless otherwise specified

Parameter	Symbol		Unit		
		min.	typ.	max.	
Static Characteristics					-
Drain-source breakdown voltage	V _{(BR)DSS}	-30	-	-	V
V _{GS} =0, / _D =-250μA					
Gate threshold voltage, $V_{GS} = V_{DS}$	V _{GS(th)}	-1	-1.5	-2	
/ _D =-430μA					
Zero gate voltage drain current	/ _{DSS}				μA
V_{DS} =-30V, V_{GS} =0, T_{j} =25°C		-	-0.1	-1	
V_{DS} =-30V, V_{GS} =0, T_{j} =150°C ³⁾		-	-10	-100	
Gate-source leakage current	I _{GSS}	-	± 10	± 100	nA
V _{GS} =±20V, V _{DS} =0					
Drain-source on-state resistance ⁴⁾	R _{DS(on)}				mΩ
V _{GS} =-4.5V, <i>I</i> _D =-50A		-	6.3	7.6	
V_{GS} =-4.5V, I_{D} =-50A, SMD version		-	6	7.3	
Drain-source on-state resistance ⁴⁾	R _{DS(on)}				
V _{GS} =-10V, / _D =-80A		-	3.5	4.3	
V _{GS} =-10V, / _D =-80A, SMD version		-	3.2	4	

¹Current limited by bondwire ; with an R_{thJC} = 0.75K/W the chip is able to carry I_D = 171A at 25°C, for detailed information see app.-note ANPS071E available at *www.infineon.com/optimos*

²Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical without blown air; t≤10 sec.

 $^{3}\mbox{Defined}$ by design. Not subject to production test.

⁴Diagrams are related to straight lead versions



Electrical Characteristics

Parameter	Symbol	Conditions	Values		i	Uni
			min.	typ.	max.	1
Dynamic Characteristics		•		•	:	•
Transconductance	g _{fs}	$ V_{\text{DS}} \ge 2 I_{\text{D}} R_{\text{DS(on)max}}$, 63	125	-	S
		/ _D =-80A				
Input capacitance	Ciss	V _{GS} =0, V _{DS} =-25V, <i>f</i> =1MHz	-	7720	-	pF
Output capacitance	C _{oss}		-	2050	-	
Reverse transfer capacitance	C _{rss}		-	1673	-	
Turn-on delay time	t _{d(on)}	V _{DD} =-15V, V _{GS} =-10V,	-	30	45	ns
Rise time	t _r	/ _D =-1A,	-	45	68	
Turn-off delay time	t _{d(off)}	$R_{G}=6\Omega$	-	200	300	
Fall time	t _f		-	180	270	
Gate Charge Characteristics	·			•	•	·
Gate to source charge	Q _{as}	V=-24V, /_=-80A	_	-25	-38	nC

Gate to source charge	Q _{gs}	V _{DD} =-24V, <i>I</i> _D =-80A	-	-25	-38	nC
Gate to drain charge	Q _{gd}	*	-	-85	-128	
Gate charge total	Qg	V _{DD} =-24V, <i>I</i> _D =-80A,	-	-200	-300	
		V _{GS} =0 to -10V				
Gate plateau voltage	V _(plateau)	V _{DD} =-24V, <i>I</i> _D =-80A	-	-3	-	V

Reverse Diode

Inverse diode continuous	I _S	<i>T</i> _A =25°C	-	-	-80	А
forward current						
Inv. diode direct current, pulsed	I _{SM}		-	-	-320	
Inverse diode forward voltage	V _{SD}	$V_{\rm GS}$ =0, $ I_F = I_D $	I	-1.1	-1.3	V
Reverse recovery time	<i>t</i> _{rr}	$V_{\rm R}$ =-15V, $ I_{\rm F} = I_{\rm D} $,	-	60	75	ns
Reverse recovery charge	Q _{rr}	d <i>i_F/dt</i> =100A/µs	-	75	95	nC



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Further information

Please notice that the part number is BIPP80P03P3L-04, BIPB80P03P3L-04 and BIPI80P03P3L-04, for simplicity the device is referred to by the term IPP80P03P3L-04, IPB80P03P3L-04 and IPI80P03P3L-04 throughout this documentation